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QME48T35120 DC-DC Converter **36-75 VDC Input; 12 VDC @ 35 A Output**



Applications

- Telecommunications Telecommunications equipment
- Data communications Data processing
- Wireless communications Wireless base stations
- Servers, Workstations LAN/WAN
- Industrial applications

Benefits

- Fully Voltage Regulated – for IBA
- High efficiency– no heat sink required¹
- Baseplate option

Description

The new high performance 35A QME48T35120 DC-DC converter provides a high efficiency single output, in a 1/4 brick package. Specifically designed for operation in systems that have limited airflow and increased ambient temperatures, the QME48T35120 converter utilizes the same pin-out and Input/Output functionality of the industry-standard quarter-bricks. In addition, a baseplate feature is available (-xxxBx suffix) that provides an effective thermal interface for coldplate and heat sinking options.

The QME48T35120 converter thermal performance is accomplished through the use of patent-pending circuits, packaging, and processing techniques to achieve ultra-high efficiency, excellent thermal management, and a low-body profile.

Low-body profile and the preclusion of heat sinks minimize impedance to system airflow, thus enhancing cooling for both upstream and downstream devices. The use of 100% automation for assembly, coupled with advanced electronic circuits and thermal design, results in a product with extremely high reliability.

Operating from a wide-range 36-75V input, the QME48T35120 converter provides a fully regulated 12.0V output voltage. Employing a standard power pin-out, the QME48T35120 converter is an ideal drop-in replacement for existing high current quarter-brick designs. Inclusion of this converter in a new design can result in significant board space and cost savings. The designer can expect reliability improvement over other available converters because of the QME48T35120 optimized thermal efficiency.

¹ Baseplate/heat spreader option (suffix '-xxxBx') facilitates heatsink mounting to further enhance the unit's thermal capability.

Features

- RoHS lead-free solder and lead-solder-exempted products are available
- Delivers up to 35 A (420 Watts)
- Industry-standard quarter-brick pinout
- On-board input differential LC-filter
- Startup into pre-biased load
- No minimum load required
- Meets Basic Insulation requirements of EN60950-1
- Withstands 100 V input transient for 100 ms
- Fixed frequency operation
- Fully protected (OTP, OCP, OVP, UVLO) with automatic recovery
- Positive or negative logic ON/OFF option
- Low height of 0.430" (10.4mm)
- Weight: 1.75 oz (49.6g), 2.15 oz (61.0g) w/baseplate
- High reliability: MTBF approx. 18.8 million hours, calculated per Telcordia TR-332, Method I Case 1
- Approved to the following Safety Standards: UL/CSA60950-1, EN60950-1, and IEC60950-1
- Designed to meet Class B conducted emissions per FCC and EN55022 when used with external filter
- All materials meet UL94, V-0 flammability rating



QME48T35120 DC-DC Converter

36-75 VDC Input; 12 VDC @ 35 A Output

Electrical Specifications

Conditions: $T_A = 25^\circ\text{C}$, Airflow = 300 LFM (1.5 m/s), $V_{in} = 48\text{ VDC}$, unless otherwise specified.

Parameter	Notes	Min	Typ	Max	Units
Absolute Maximum Ratings					
Input Voltage	Continuous	0		80	VDC
	Transient (100ms)			100	VDC
Operating Temperature (See Derating Curves)	Ambient (T_A)	-40		85	$^\circ\text{C}$
	(Note: 1) Component (T_C)	-40		125	$^\circ\text{C}$
	Baseplate (T_B)	-40		105	$^\circ\text{C}$
Storage Temperature		-55		125	$^\circ\text{C}$
Isolation Characteristics					
I/O Isolation (suffix 'xxx0x')	[Input-to-Output]	1,500			VDC
Isolation Capacitance			1300		pF
Isolation Resistance		10			M Ω
I/O Isolation (suffix 'xxxBx')	[Input-to-Output & Baseplate-to-Input/Output]	1,500			VDC
Isolation Capacitance	[Input-to-Output]		1300		pF
Isolation Resistance	[Input-to-Output & Baseplate-to-Input/Output]	10			M Ω
Feature Characteristics					
Switching Frequency			250		kHz
Output Voltage Trim Range ²			n/a		%
Remote Sense Compensation ²			n/a		%
Output Overvoltage Protection	Non-latching	117	122	127	%
Overtemperature Shutdown (PCB)	Non-latching		130		$^\circ\text{C}$
Auto-Restart Period	Applies to all protection features		200		ms
Turn-On Time including Rise Time	20,000 μF plus Full Load (resistive)		15	30	ms
Rise Time	From 10% to 90%		13	25	ms
Turn-On Time from V_{in}	Time from UVLO to $V_o=90\%V_{OUT(NOM)}$ Resistive load	3	5	10	ms
Turn-On Time from ON/OFF Control	Time from ON to $V_o=90\%V_{OUT(NOM)}$ Resistive load		12		ms
Turn-On Time from V_{in} (w/ C_{ext} max.)	Time from UVLO to $V_o=90\%V_{OUT(NOM)}$ Resistive load, $C_{EXT}=10,000\mu\text{F}$ load	5	10	25	ms
Turn-On Time from ON/OFF Control (w/ C_{ext} max.)	Time from ON to $V_o=90\%V_{OUT(NOM)}$ Resistive load, $C_{EXT}=10,000\mu\text{F}$ load		14		ms
ON/OFF Control (Positive Logic)	Converter Off (logic low)	-20		0.8	VDC
	Converter On (logic high)	2.4		20	VDC
ON/OFF Control (Negative Logic)	Converter Off (logic high)	2.4		20	VDC
	Converter On (logic low)	-20		0.8	VDC

Additional Notes:

- ¹. Reference Figure E for component (T_C and T_B) locations.
- ². This functionality not provided, however the unit is fully regulated.



QME48T35120 DC-DC Converter

36-75 VDC Input; 12 VDC @ 35 A Output

Electrical Specifications (continued)

Conditions: $T_A = 25^\circ\text{C}$, Airflow = 300 LFM (1.5 m/s), $V_{in} = 48\text{ VDC}$, unless otherwise specified.

Parameter	Notes	Min	Typ	Max	Units
Input Characteristics					
Operating Input Voltage Range		36	48	75	VDC
Input Under Voltage Lockout	Non-latching				
Turn-on Threshold		31.5	34	35.5	VDC
Turn-off Threshold		30	33	34.5	VDC
Lockout Hysteresis Voltage		0.5		2	VDC
Input Voltage Transient Rate				7	V/ms
Maximum Input Current	35 ADC, 12 VDC Out @ 36 VDC In			12.3	ADC
Input Stand-by Current	converter disabled		10		mADC
Input Current @ No Load	converter enabled		95		mADC
Minimum Input Capacitance (external)	ESR < 0.7 Ω	150			μF
Inrush Transient				0.1	A^2s
Input Reflected-Ripple Current, i_c	25 MHz bandwidth, $I_o = 35\text{ Amperes}$ (Figure 34)		1250		$\text{mA}_{\text{PK-PK}}$
Input Reflected-Ripple Current, i_s			100		$\text{mA}_{\text{PK-PK}}$
Input Voltage Ripple Rejection	120 Hz		45		dB
Output Characteristics					
Output Voltage Set Point (no load) ¹		11.76	12.00	12.24	VDC
Output Regulation ¹					
Over Line	$V_{in} = 39\text{ to }75\text{VDC}$ [$I_{OUT} = 35\text{Amps}$]		± 60	± 120	mV
Over Load			± 60	± 120	mV
Output Voltage Range ¹	Over line (39 to 75VDC), load and temp. ²	11.64		12.36	VDC
	Over line (36 to 75VDC), load and temp. ²	11.00		12.36	VDC
Output Ripple and Noise – 20 MHz bandwidth	$I_{OUT} = 35\text{Amps}$, $C_{EXT} = 10\text{ }\mu\text{F}$ tantalum + 1 μF ceramic		100	150	$\text{mV}_{\text{PK-PK}}$
				60	mV_{rms}
External Load Capacitance ⁴	Full Load (resistive) C_{EXT} ESR	0 1		20,000	μF m Ω
Output Current Range		0		35	ADC
Current Limit Inception	Non-latching	110		143	% I_{omax}
Peak Short-Circuit Current ³	Non-latching, Short = 10 m Ω		55	70	A
RMS Short-Circuit Current	Non-latching		5		Arms
Dynamic Response					
Load Change 50%-75%-50%, $di/dt = 0.1\text{A}/\mu\text{s}$	$C_o = 1\text{ }\mu\text{F}$ ceramic + 10 μF tantalum		200	360	mV
$di/dt = 1\text{ A}/\mu\text{s}$	$C_o = 1\text{ }\mu\text{F}$ ceramic + 10 μF tantalum		350	540	mV
Settling Time to 1% of V_{OUT}			200		μs
Efficiency					
100% Load	$V_{in} = 39\text{VDC}$		95		%
50% Load	$V_{in} = 39\text{VDC}$		96		%

Additional Notes:

¹ Measured at the output pins of the converter.

² Operating ambient temperature range of -40°C to 85°C for converter.

³ Peak currents exist for approximately 500 μs per 200msec period.

⁴ See "Input & Output Impedance", Page 5.



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Environment and Mechanical Specifications

Environmental					
Operating Humidity	Non-condensing			95	%
Storage Humidity	Non-condensing			95	%
Mechanical					
Weight	No baseplate	1.75 [49.6]			oz [g]
	With baseplate	2.15 [61.0]			
Vibration	GR-63-CORE, Sect. 5.4.2	1			g
Shocks	Half Sinewave, 3-axis	50			g
Reliability					
MTBF	Telcordia SR-332, Method I Case 1 50% electrical stress, 40°C components	18.8			MHrs
EMI and Regulatory Compliance					
Conducted Emissions	CISPR 22 B with external EMI filter network (See Fig. 36)				



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Operations

Input and Output Impedance

These power converters have been designed to be stable with no external capacitors when used in low inductance input and output circuits.

In many applications, the inductance associated with the distribution from the power source to the input of the converter can affect the stability of the converter. The addition of a 150 μF electrolytic capacitor with an ESR $< 0.7 \Omega$ across the input helps to ensure stability of the converter. In many applications, the user has to use decoupling capacitance at the load. The power converter will exhibit stable operation with external load capacitance up to 20,000 μF .

Additionally, see the EMC section of this data sheet for discussion of other external components which may be required for control of conducted emissions.

ON/OFF (Pin 2)

The ON/OFF pin is used to turn the power converter on or off remotely via a system signal. There are two remote control options available, positive and negative logic, with both referenced to $V_{in}(-)$. A typical connection is shown in Fig. A.

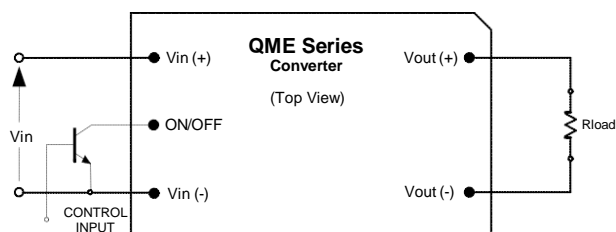


Fig. A: Circuit configuration for ON/OFF function.

The positive logic version turns on when the ON/OFF pin is at logic high and turns off when at logic low. The converter is on when the ON/OFF pin is left open. See the Electrical Specifications for logic high/low definitions.

The negative logic version turns on when the ON/OFF pin is at logic low and turns off when the ON/OFF pin is at logic high. The ON/OFF pin can be hardwired directly to $V_{in}(-)$ to enable automatic power up of the converter without the need of an external control signal.

The ON/OFF pin is internally pulled up to 5 V through a resistor. A properly debounced mechanical switch, open-collector transistor, or FET can be used to drive the input of the ON/OFF pin. The device must be capable of sinking up to 0.2mA at a low

level voltage of $\leq 0.8 \text{ V}$. An external voltage source ($\pm 20 \text{ V}$ maximum) may be connected directly to the ON/OFF input, in which case it must be capable of sourcing or sinking up to 1mA depending on the signal polarity. See the Startup Information section for system timing waveforms associated with use of the ON/OFF pin.

The converter's output overvoltage protection (OVP) senses the voltage across $V_{out}(+)$ and $V_{out}(-)$, so the resistance (and resulting voltage drop) between the output pins of the converter and the load should be minimized to prevent unwanted triggering of the OVP function.

Protection Features

Input Undervoltage Lockout

Input undervoltage lockout is standard with this converter. The converter will shut down when the input voltage drops below a pre-determined voltage.

The input voltage must be typically 34 V for the converter to turn on. Once the converter has been turned on, it will shut off when the input voltage drops typically below 33 V. This feature is beneficial in preventing deep discharging of batteries used in telecom applications.

Output Overcurrent Protection (OCP)

The converter is protected against overcurrent or short circuit conditions. Upon sensing an overcurrent condition, the converter will switch to constant current operation and thereby begin to reduce output voltage. When the output voltage drops below approx. 60% of the nominal value of output voltage, the converter will shut down.

Once the converter has shut down, it will attempt to restart nominally every 200 ms with a typical 3% duty cycle. The attempted restart will continue indefinitely until the overload or short circuit conditions are removed or the output voltage rises above 60% of its nominal value.

Once the output current is brought back into its specified range, the converter automatically exits the hiccup mode and continues normal operation.

Output Overvoltage Protection (OVP)

The converter will shut down if the output voltage across $V_{out}(+)$ (Pin 5) and $V_{out}(-)$ (Pin 4) exceeds the threshold of the OVP circuitry. The OVP circuitry contains its own reference, independent of the output voltage regulation loop. Once the converter has shut down, it will attempt to restart every 200 ms until the OVP condition is removed.



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Overtemperature Protection (OTP)

The converter will shut down under an overtemperature condition to protect itself from overheating caused by operation outside the thermal derating curves, or operation in abnormal conditions such as system fan failure. After the converter has cooled to a safe operating temperature, it will automatically restart.

Safety Requirements

The converters are safety approved to UL/CSA60950-1, EN60950-1, and IEC60950-1. Basic Insulation is provided between input and output.

The converters have no internal fuse. To comply with safety agencies requirements, an input line fuse must be used external to the converter. A 20-A fuse is recommended for use with this product.

The QME48T35120 converter is CSA approved for a maximum fuse rating of 20A.

Electromagnetic Compatibility (EMC)

EMC requirements must be met at the end-product system level, as no specific standards dedicated to EMC characteristics of board mounted component dc-dc converters exist. However, Power-One tests its converters to several system level standards, primary of which is the more stringent EN55022, *Information technology equipment - Radio disturbance characteristics-Limits and methods of measurement*.

An effective internal LC differential filter significantly reduces input reflected ripple current, and improves EMC.

With the addition of a simple external filter, the QME48T35120 converter will pass the requirements of Class B conducted emissions per EN55022 and FCC requirements. Refer to Figures 36 and 37 for typical performance with external filter.

Absence of the Remote Sense Pins

Users should note that this converter does not have a Remote Sense feature. Care should be taken to minimize voltage drop on the user's motherboard.



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Startup Information (using negative ON/OFF)

Scenario #1: Initial Startup From Bulk Supply

ON/OFF function enabled, converter started via application of V_{IN} . See Figure B.

Time	Comments
t_0	ON/OFF pin is ON; system front end power is toggled on, V_{IN} to converter begins to rise.
t_1	V_{IN} crosses undervoltage Lockout protection circuit threshold; converter enabled.
t_2	Converter begins to respond to turn-on command (converter turn-on delay).
t_3	Converter V_{OUT} reaches 100% of nominal value.

For this example, the total converter startup time ($t_3 - t_1$) is typically 8 ms.

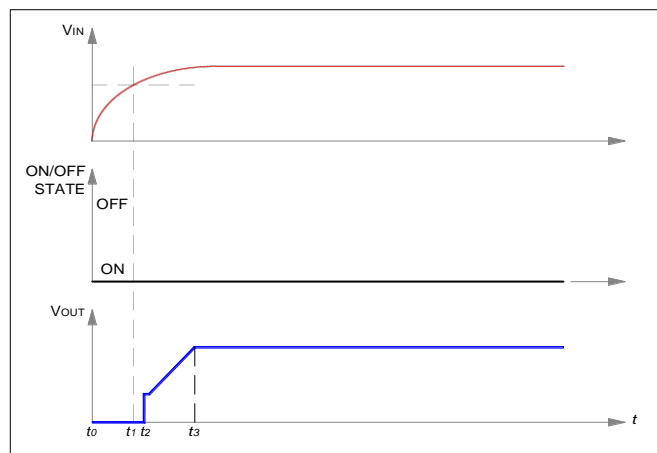


Fig. B: Startup scenario #1.

Scenario #2: Initial Startup Using ON/OFF Pin

With V_{IN} previously powered, converter started via ON/OFF pin. See Figure C.

Time	Comments
t_0	V_{INPUT} at nominal value.
t_1	Arbitrary time when ON/OFF pin is enabled (converter enabled).
t_2	End of converter turn-on delay.
t_3	Converter V_{OUT} reaches 100% of nominal value.

For this example, the total converter startup time ($t_3 - t_1$) is typically 8 ms.

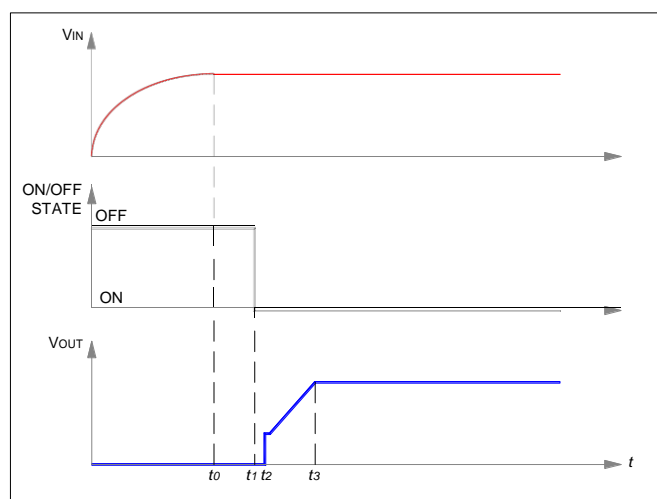


Fig. C: Startup scenario #2.

Scenario #3: Turn-off and Restart Using ON/OFF Pin

With V_{IN} previously powered, converter is disabled and then enabled via ON/OFF pin. See Figure D.

Time	Comments
t_0	V_{IN} and V_{OUT} are at nominal values; ON/OFF pin ON.
t_1	ON/OFF pin arbitrarily disabled; converter output falls to zero; turn-on inhibit delay period (200 ms typical) is initiated, and ON/OFF pin action is internally inhibited.
t_2	ON/OFF pin is externally re-enabled. If $(t_2 - t_1) \leq 200$ ms, external action of ON/OFF pin is locked out by startup inhibit timer. If $(t_2 - t_1) > 200$ ms, ON/OFF pin action is internally enabled.
t_3	Turn-on inhibit delay period ends. If ON/OFF pin is ON, converter begins turn-on; if off, converter awaits ON/OFF pin ON signal; see Figure D.
t_4	End of converter turn-on delay.
t_5	Converter V_{OUT} reaches 100% of nominal value.

For the condition, $(t_2 - t_1) \leq 200$ ms, the total converter startup time ($t_5 - t_2$) is typically 208 ms. For $(t_2 - t_1) > 200$ ms, startup will be typically 8 ms after release of ON/OFF pin.

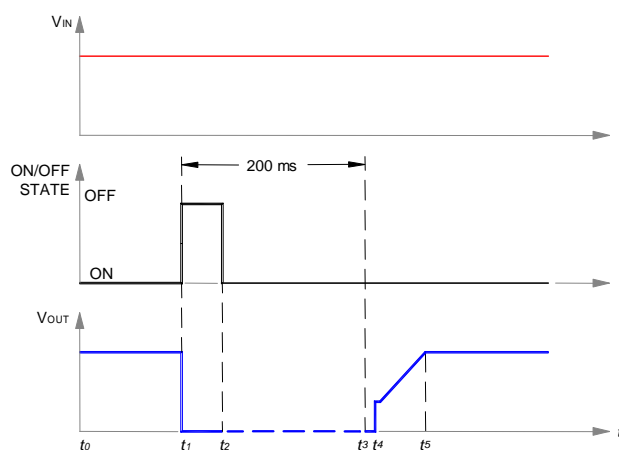


Fig. D: Startup scenario #3.



QME48T35120 DC-DC Converter 36-75 VDC Input; 12 VDC @ 35 A Output

Characterization

General Information

The converter has been characterized for many operational aspects, to include thermal derating (maximum load current as a function of ambient temperature and airflow) for vertical and horizontal mountings, efficiency, startup and shutdown parameters, output ripple and noise, transient response to load step-change, overload, and short circuit.

Test Conditions

All data presented were taken with the converter soldered to a test board, specifically a 0.060" thick printed wiring board (PWB) with four layers. The top and bottom layers were not metalized. The two inner layers, comprised of two-ounce copper, were used to provide traces for connectivity to the converter.

The lack of metallization on the outer layers as well as the limited thermal connection ensured that heat transfer from the converter to the PWB was minimized. This provides a worst-case but consistent scenario for thermal derating purposes.

All measurements requiring airflow were made in the vertical and horizontal wind tunnel using Infrared (IR) thermography and thermocouples for thermometry.

Ensuring components on the converter do not exceed their ratings is important to maintaining high reliability. If one anticipates operating the converter at or close to the maximum loads specified in the derating curves, it is prudent to check actual operating temperatures in the application. Thermographic imaging is preferable; if this capability is not available, then thermocouples may be used. The use of AWG #36 gauge thermocouples is recommended to ensure measurement accuracy. Careful routing of the thermocouple leads will further minimize measurement error. Refer to Fig. E for the optimum measuring thermocouple location.

Thermal Derating

Thermal characterization is provided for the hotspot temperatures of both 120°C and 125°C.

Load current vs. ambient temperature and airflow rates are shown in Fig. 1, Fig. 3, Fig. 5 and Fig. 7. Ambient temperature was varied between 25°C and 85°C, with airflow rates from 30 to 500 LFM (0.15 to 2.5 m/s).

For each set of conditions, the maximum load current was defined as the lowest of:

Case I : T_C (Hotspot) $\leq 120^\circ\text{C}$

- (i) The output current at which any FET junction (T_J) temperature does not exceed a maximum temperature of 120°C as indicated by the thermal measurement, or
- (ii) The output current at which the temperature at the thermocouple locations T_C do not exceed 120°C. (Fig. E)
- (iii) The nominal rating of the converter (35 A).

Case II : T_C (Hotspot) $\leq 125^\circ\text{C}$

- (i) The output current at which any FET junction (T_J) temperature does not exceed a maximum temperature of 125°C as indicated by the thermal measurement, or
- (ii) The output current at which the temperature at the thermocouple locations T_C do not exceed 125°C. (Fig. E)
- (iii) The nominal rating of the converter (35 A).

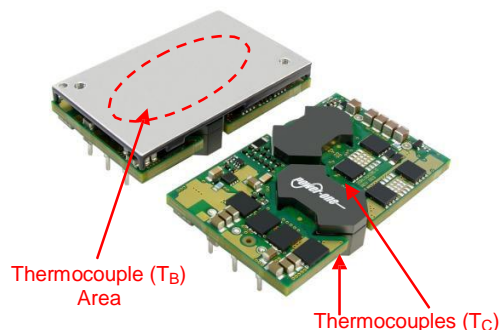


Fig. E: Location of the thermocouples for thermal testing.

Output Power

The output power vs. ambient temperature and airflow rates are given in Fig. 2 and Fig. 4 w/o baseplate. The output power vs. ambient temperature and airflow rates are given in Fig. 6 and Fig. 8 with baseplate. The ambient temperature varies between 25°C and 85°C with airflow rates from 30 to 500 LFM (0.15 to 2.5 m/s).



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Thermal Derating – Baseplate Cooled

The maximum load current rating vs. baseplate temperature is provided for Baseplate Models with commercially available heatsinks attached. The various configurations, T_{C-MAX} (Hotspot) and Figure references, are listed below.

Note: T_C Hotspot $\approx T_{J MOSFET}$

For a 1/4" heatsink, AAvid Thermalloy PNU 241402B92200G, $T_C \leq 120^\circ\text{C}$, current derating is provided in Figure 9. Power Derating is provided in Figure 10.

For a 1/4" heatsink, AAvid Thermalloy PNU 241402B92200G, $T_C \leq 125^\circ\text{C}$, current derating is provided in Figure 11. Power Derating is provided in Figure 12.

For a 1/2" heatsink, AAvid Thermalloy PNU 241404B92200G, $T_C \leq 120^\circ\text{C}$, current derating is provided in Figure 13. Power Derating is provided in Figure 14.

For a 1/2" heatsink, AAvid Thermalloy PNU 241404B92200G, $T_C \leq 125^\circ\text{C}$, current derating is provided in Figure 15. Power Derating is provided in Figure 16.

For a 1" heatsink, AAvid Thermalloy PNU 241409B92200G, $T_C \leq 120^\circ\text{C}$, current derating is provided in Figure 17. Power Derating is provided in Figure 18.

For a 1" heatsink, AAvid Thermalloy PNU 241409B92200G, $T_C \leq 125^\circ\text{C}$, current derating is provided in Figure 19. Power Derating is provided in Figure 20.

Thermal Derating – Coldplate Cooled

The converter was shielded from air flow. The baseplate temperature was maintained $\leq 85^\circ\text{C}$, with an airflow rate of $\geq 30\text{LFM}$ ($\geq 0.15\text{m/s}$). Thermocouple measurements (in Fig. E) were recorded as $T_C \leq 120^\circ\text{C}$ and $T_B \leq 85^\circ\text{C}$. Refer to Figure 21 and Figure 22.

Efficiency

Efficiency vs. load current is showing in Fig. 23 for ambient temperature (T_A) of 25°C , airflow rate of 300LFM (1.5m/s) with vertical mounting and input voltages of 36V, 48V, and 75V. Also, a plot of efficiency vs. load current, as a function of ambient temperature with $V_{in} = 48\text{V}$, airflow rate of 200LFM (1m/s) with vertical mounting is shown in Fig. 24.

Power Dissipation

Power dissipation vs. load current is showing in Fig. 25 for $T_A = 25^\circ\text{C}$, airflow rate of 300LFM (1.5m/s) with vertical mounting and input voltages of 36V, 48V, and 75V. Also, a plot of power dissipation vs. load current, as a function of ambient temperature with $V_{in} = 48\text{V}$, airflow rate of 200LFM (1m/s) with vertical mounting is shown in Fig. 26.

Startup

Output voltage waveforms, during the turn-on transient using the ON/OFF pin for full rated load currents (resistive load) are shown without and with external load capacitance in Fig. 27 and Fig. 28, respectively.

Ripple and Noise

Fig. 31 show the output voltage ripple waveform, measured at full rated load current with a $10\text{ }\mu\text{F}$ tantalum and $1\text{ }\mu\text{F}$ ceramic capacitor across the output. Note that all output voltage waveforms are measured across a $1\text{ }\mu\text{F}$ ceramic capacitor.

The input reflected ripple current waveforms are obtained using the test setup shown in Fig. 32. The corresponding waveforms are shown in Fig. 33 and Fig. 34.



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Figures 1 & 2 without Baseplate, $T_C \leq 120^\circ\text{C}$

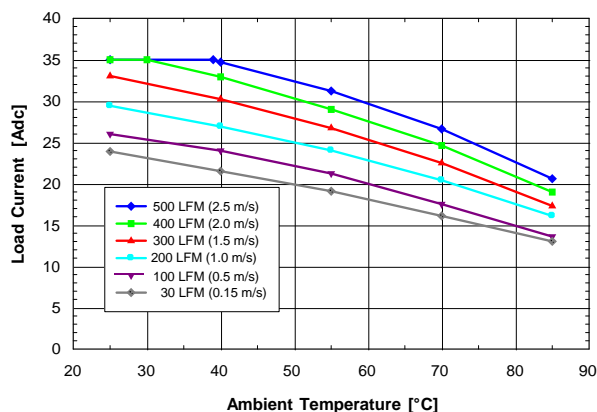


Fig. 1: Available output current vs. ambient air temperature and airflow rates for converter w/o baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$.

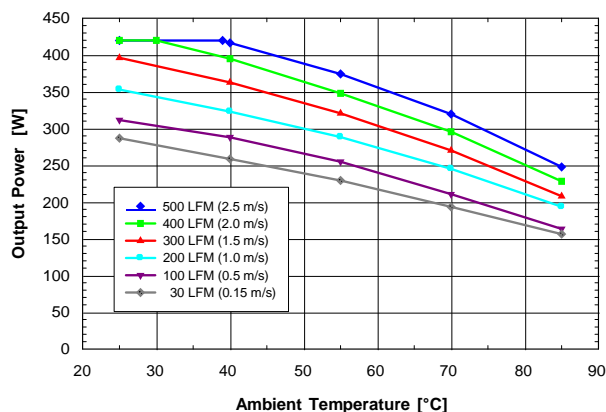


Fig. 2: Available output power vs. ambient air temperature and airflow rates for converter w/o baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$.

Figures 3 & 4 with Baseplate, $T_C \leq 120^\circ\text{C}$

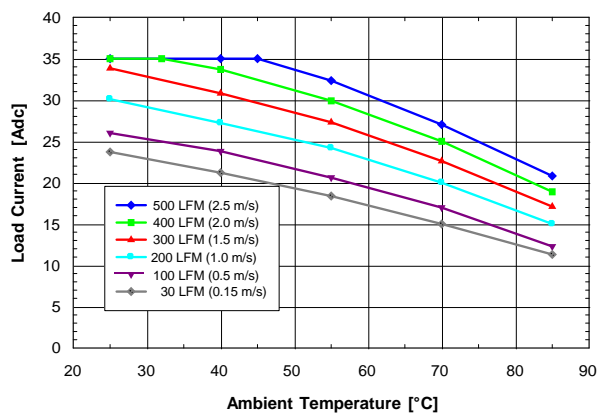


Fig. 3: Available output current vs. ambient air temperature and airflow rates for converter with baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$.

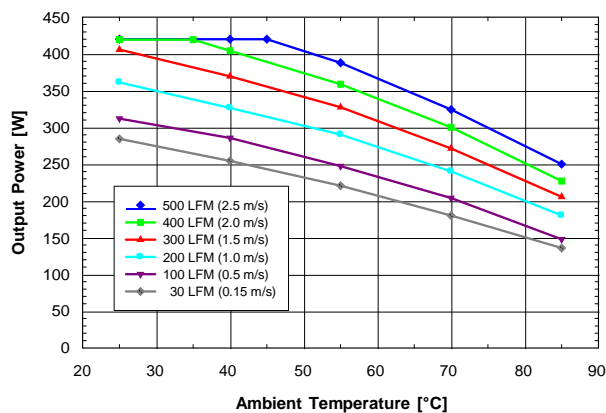


Fig. 4: Available output power vs. ambient air temperature and airflow rates for converter with baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$.



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Figures 5 & 6 without Baseplate, $T_C \leq 125^\circ\text{C}$

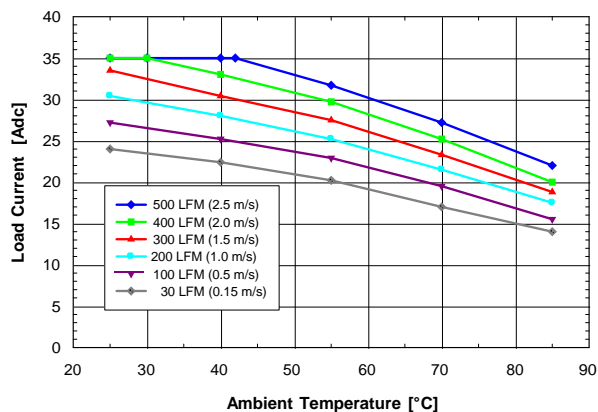


Fig. 5: Available output current vs. ambient air temperature and airflow rates for converter w/o baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$.

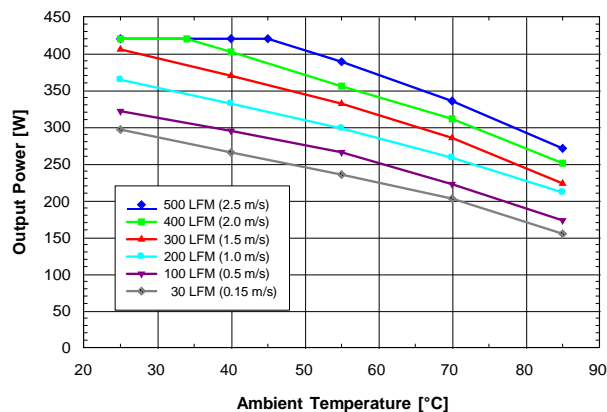


Fig. 6: Available output power vs. ambient air temperature and airflow rates for converter w/o baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$.

Figures 7 & 8 with Baseplate, $T_C \leq 125^\circ\text{C}$

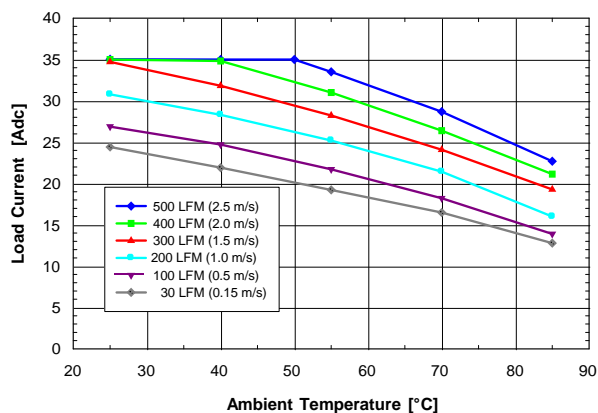


Fig. 7: Available output current vs. ambient air temperature and airflow rates for converter with baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$.

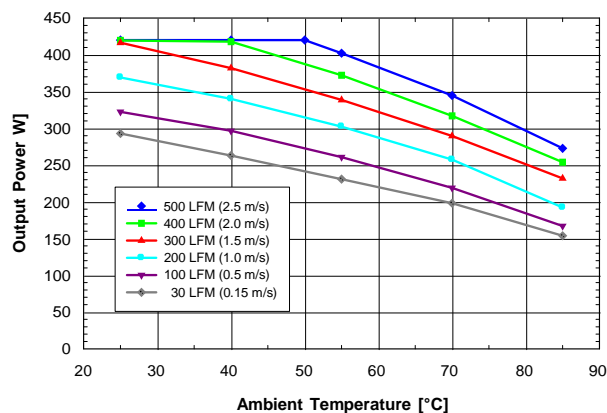


Fig. 8: Available output power vs. ambient air temperature and airflow rates for converter with baseplate mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$.



QME48T35120 DC-DC Converter 36-75 VDC Input; 12 VDC @ 35 A Output

Figures 9 & 10 with 1/4" Finned Heatsink, $T_C \leq 120^\circ\text{C}$

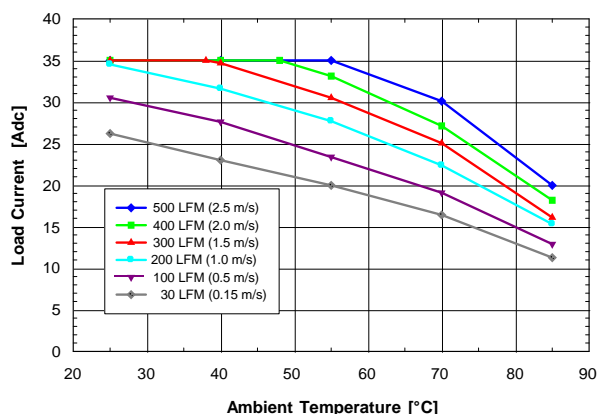


Fig. 9: Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$, 1/4" Heatsink.

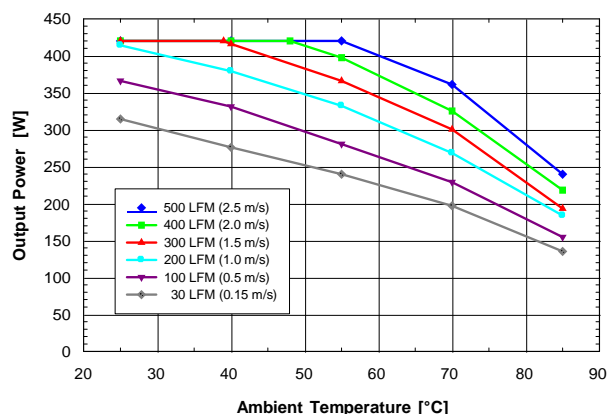


Fig. 10: Available output power vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$, 1/4" Heatsink.

Figures 11 & 12 th 1/4" Finned Heatsink, $T_C \leq 125^\circ\text{C}$

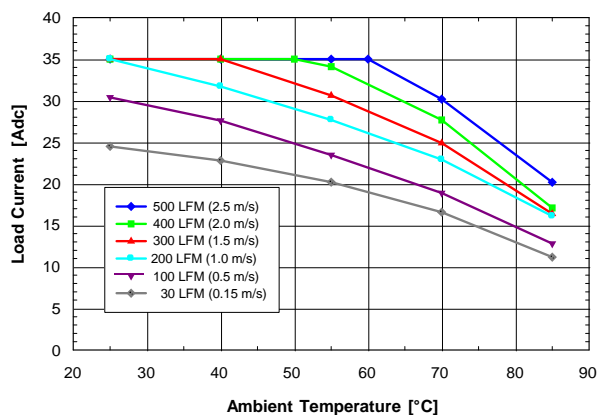


Fig. 11: Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$, 1/4" Heatsink.

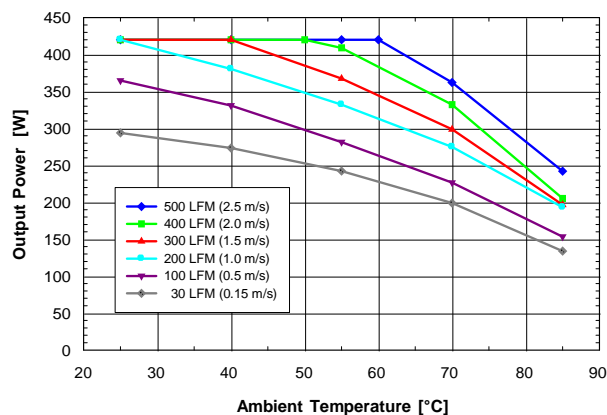


Fig. 12: Available output power vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$, 1/4" Heatsink.



QME48T35120 DC-DC Converter 36-75 VDC Input; 12 VDC @ 35 A Output

Figures 13 & 14 with ½" Finned Heatsink, $T_C \leq 120^\circ\text{C}$

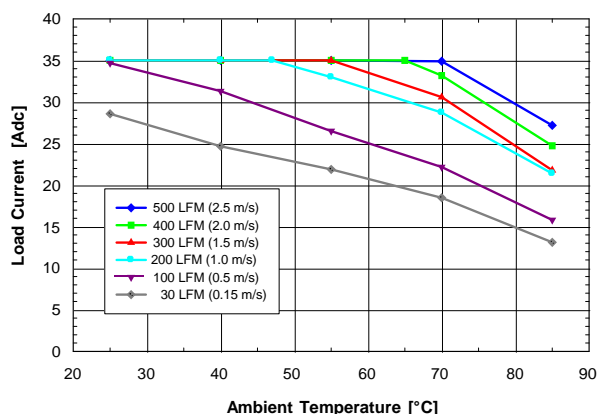


Fig. 13: Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$, ½" Heatsink.

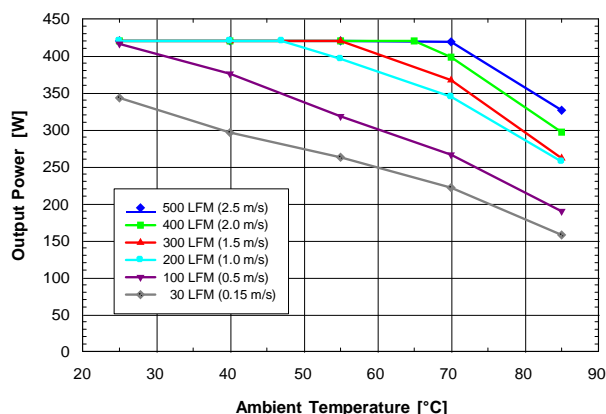


Fig. 14: Available output power vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$, ½" Heatsink.

Figures 15 & 16 with ½" Finned Heatsink, $T_C \leq 125^\circ\text{C}$

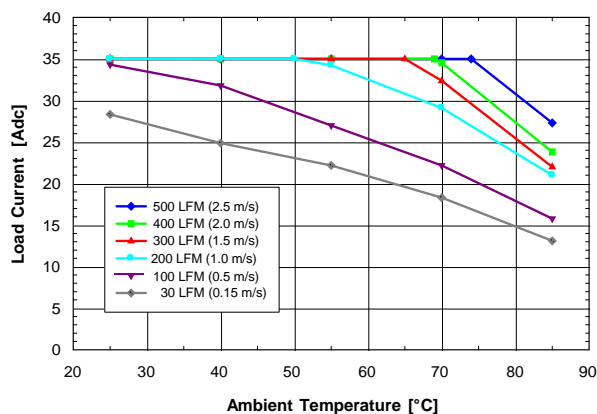


Fig. 15: Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$, ½" Heatsink.

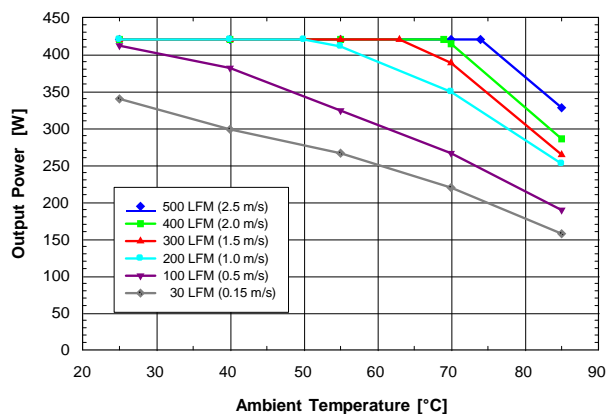


Fig. 16: Available output power vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$, ½" Heatsink.



QME48T35120 DC-DC Converter 36-75 VDC Input; 12 VDC @ 35 A Output

Figures 17& 18 with 1" Finned Heatsink, $T_C \leq 120^\circ\text{C}$

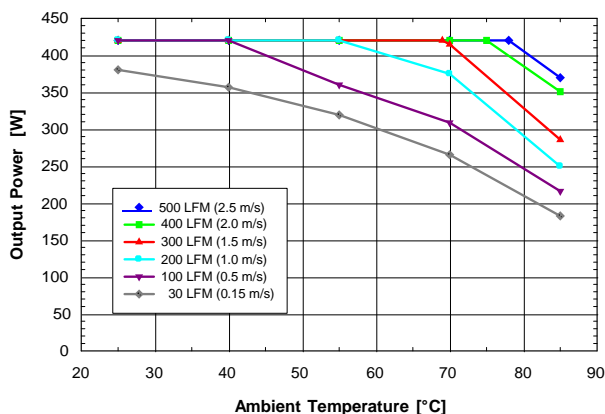


Fig. 17: Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$, 1" Heatsink.

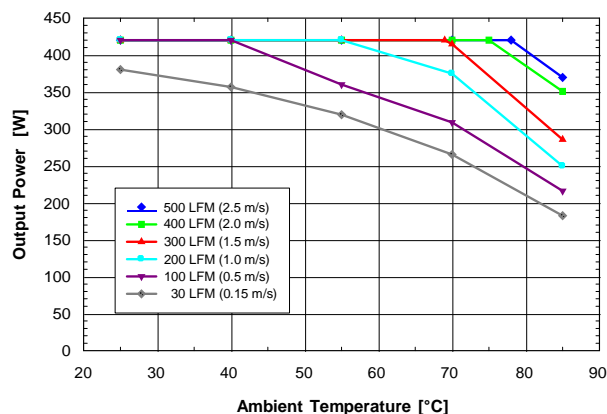


Fig. 18: Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 120^\circ\text{C}$, $V_{in} = 48\text{ V}$, 1" Heatsink.

Figures 19 & 20 with 1" Finned Heatsink, $T_C \leq 125^\circ\text{C}$

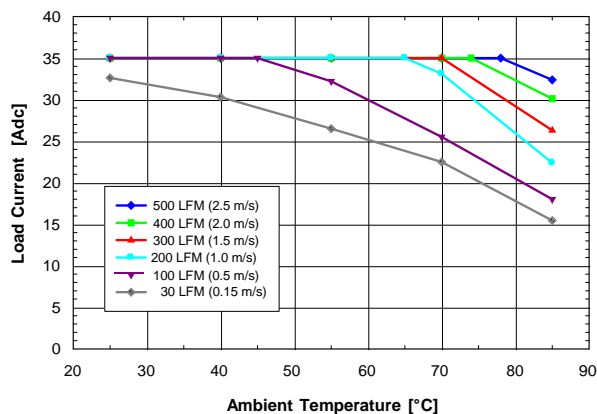


Fig. 19: Available output current vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$, 1" Heatsink.

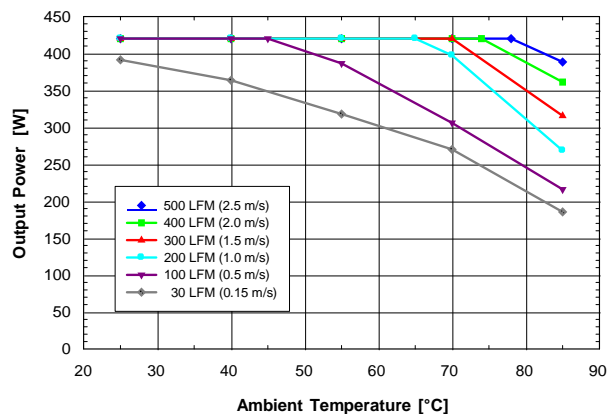


Fig. 20: Available output power vs. ambient air temperature and airflow rates for converter mounted vertically with air flowing from pin 1 to pin 3, MOSFET temperature $\leq 125^\circ\text{C}$, $V_{in} = 48\text{ V}$, 1" Heatsink.



QME48T35120 DC-DC Converter 36-75 VDC Input; 12 VDC @ 35 A Output

Figures 21 & 22 Coldplate Cooling, $T_c \leq 120^\circ\text{C}$

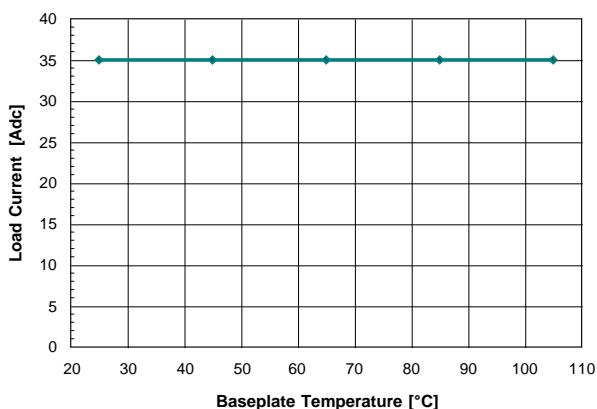


Fig. 21: Current derating of QME48T35120 converter with baseplate option and coldplate cooling. (Conditions: Air velocity $\geq 30\text{LFM}$ ($\geq 0.15\text{m/s}$), $V_{in} = 48\text{ V}$, $T_B \leq 85^\circ\text{C}$, $T_c \leq 120^\circ\text{C}$. No thermal derating required.

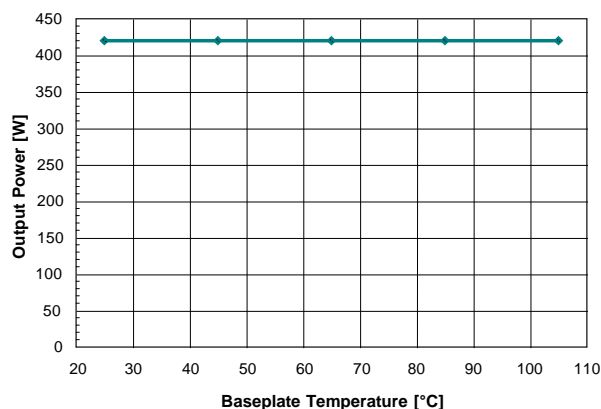


Fig. 22: Power derating of QME48T35120 converter with baseplate option and coldplate cooling. (Conditions: Air velocity $\geq 30\text{LFM}$ ($\geq 0.15\text{m/s}$), $V_{in} = 48\text{ V}$, $T_B \leq 85^\circ\text{C}$, $T_c \leq 120^\circ\text{C}$. No thermal derating required.

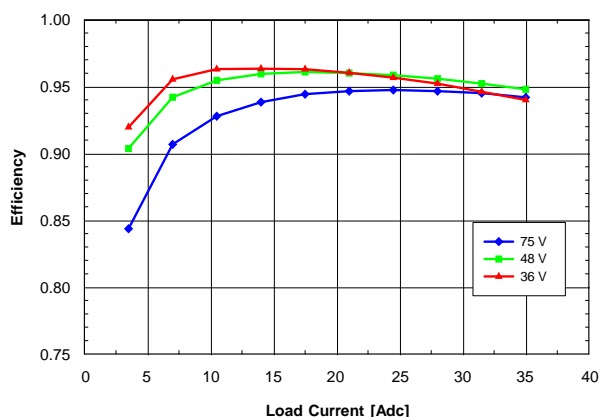


Fig. 23: Efficiency vs. load current and input voltage for converter w/o baseplate mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5 m/s) and $T_a = 25^\circ\text{C}$.

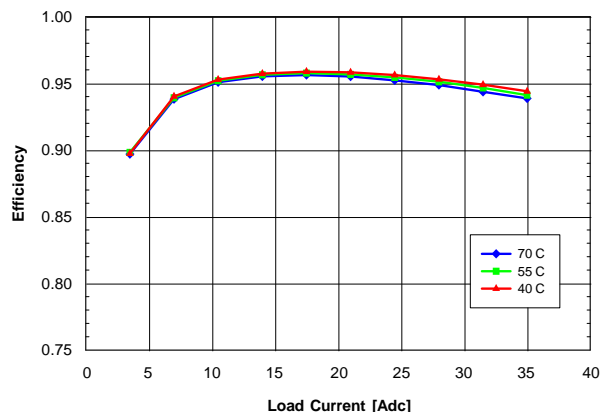


Fig. 24: Efficiency vs. load current and ambient temperature for converter w/o baseplate mounted vertically with $V_{in} = 48\text{ V}$ and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0 m/s).

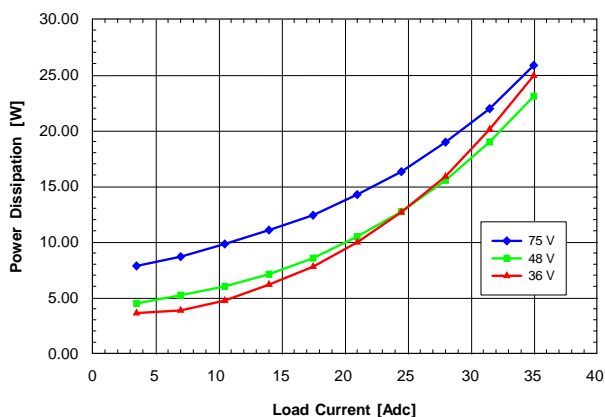


Fig. 25: Power dissipation vs. load current and input voltage for converter w/o baseplate mounted vertically with air flowing from pin 3 to pin 1 at a rate of 300 LFM (1.5 m/s) and $T_a = 25^\circ\text{C}$.

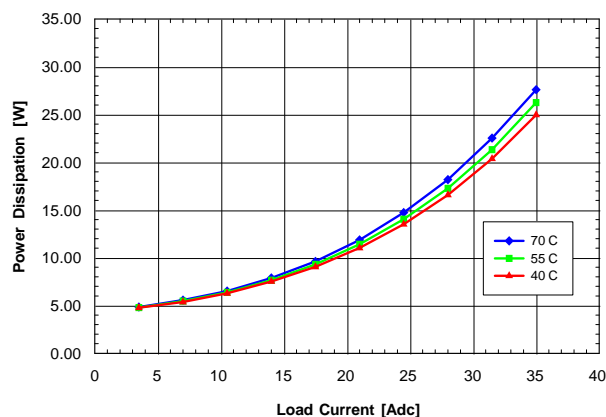


Fig. 26: Power dissipation vs. load current and ambient temperature for converter w/o baseplate mounted vertically with $V_{in} = 48\text{ V}$ and air flowing from pin 3 to pin 1 at a rate of 200 LFM (1.0 m/s).



QME48T35120 DC-DC Converter
36-75 VDC Input; 12 VDC @ 35 A Output

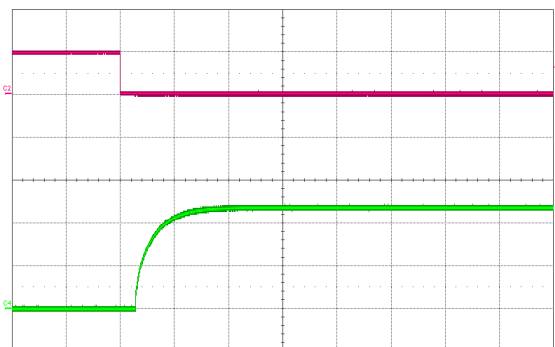


Fig. 27: Turn-on transient at full rated load current (resistive) with no output capacitor at $V_{in} = 48\text{ V}$, triggered via ON/OFF pin. Top trace: ON/OFF signal (5 V/div.). Bottom trace: output voltage (5 V/div.). Time scale: 5 ms/div.

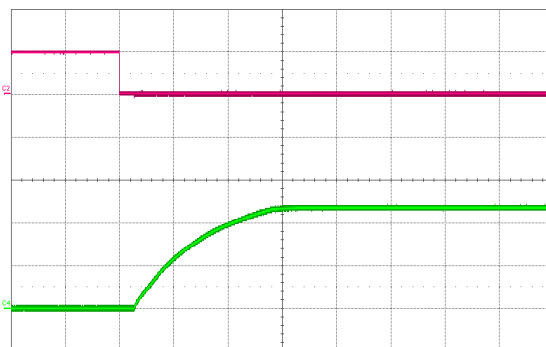


Fig. 28: Turn-on transient at full rated load current (resistive) plus 20,000 μF at $V_{in} = 48\text{ V}$, triggered via ON/OFF pin. Top trace: ON/OFF signal (5 V/div.). Bottom trace: output voltage (5 V/div.). Time scale: 5 ms/div.

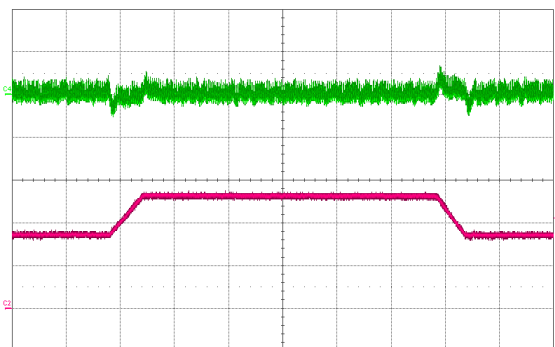


Fig. 29: Output voltage response to load current step-change (17.5 A – 26.25 A – 17.5 A) at $V_{in} = 48\text{ V}$. Top trace: output voltage (100 mV/div.). Bottom trace: load current (10 A/div.). Current slew rate: 0.1 A/ μs . $C_o = 1\text{ }\mu\text{F}$ ceramic + 10 μF tantalum. Time scale: 200 μs /div.

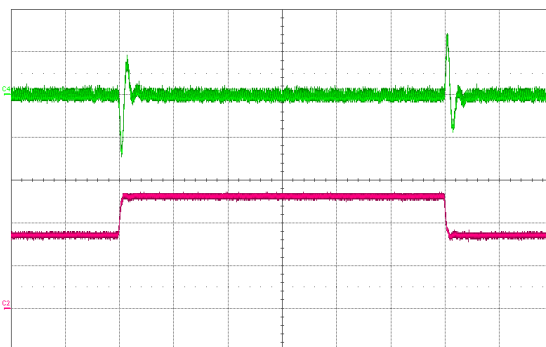


Fig. 30: Output voltage response to load current step-change (17.5 A – 26.25 A – 17.5 A) at $V_{in} = 48\text{ V}$. Top trace: output voltage (200 mV/div.). Bottom trace: load current (10 A/div.). Current slew rate: 1 A/ μs . $C_o = 1\text{ }\mu\text{F}$ ceramic + 10 μF tantalum. Time scale: 200 μs /div.



QME48T35120 DC-DC Converter 36-75 VDC Input; 12 VDC @ 35 A Output

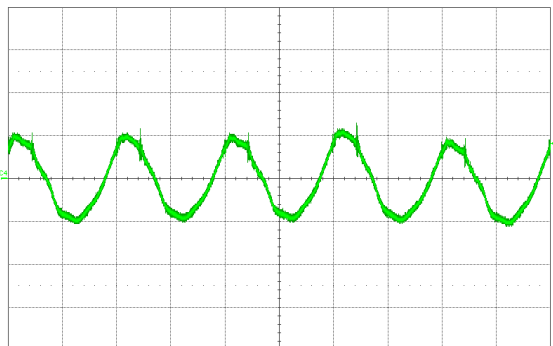


Fig. 31: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with $C_o = 10 \mu\text{F}$ tantalum + $1 \mu\text{F}$ ceramic and $V_{in} = 48 \text{ V}$. Time scale: 2 $\mu\text{s}/\text{div}$.

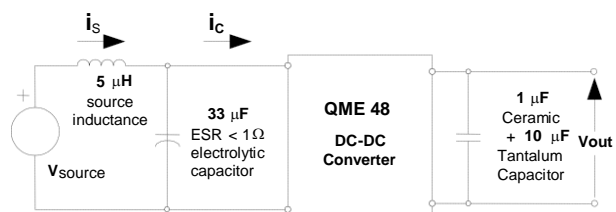


Fig. 32: Test setup for measuring input reflected ripple currents, i_c and i_s .

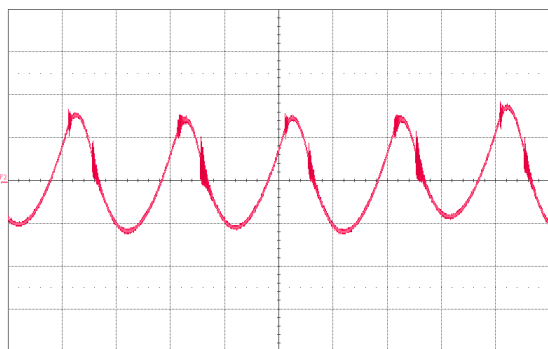


Fig. 33: Input reflected ripple current, i_c (500 mA/div.), measured at input terminals at full rated load current and $V_{in} = 48 \text{ V}$. Refer to Fig. 32 for test setup. Time scale: 2 $\mu\text{s}/\text{div}$.

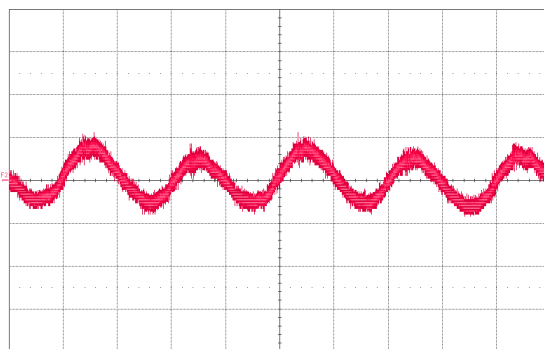


Fig. 34: Input reflected ripple current, i_s (50 mA/div.), measured through 5 μH at the source at full rated load current and $V_{in} = 48 \text{ V}$. Refer to Fig. 32 for test setup. Time scale: 2 $\mu\text{s}/\text{div}$.

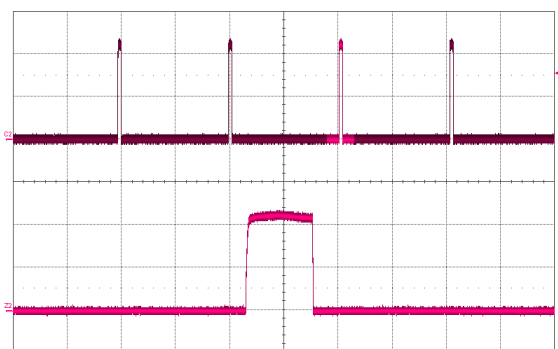
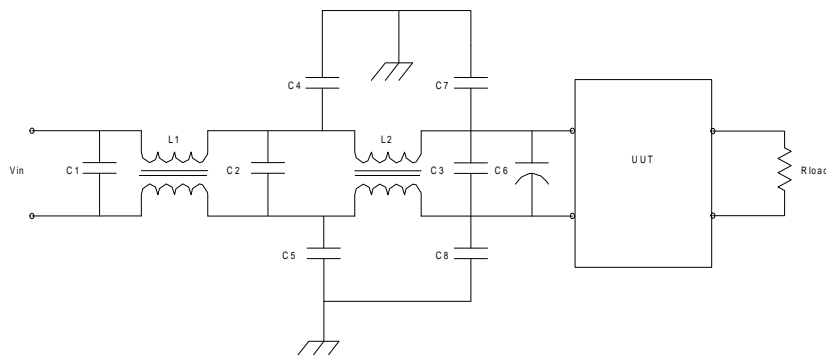


Fig. 35: Load current (top trace, 20 A/div., 100 ms/div.) into a 10 m Ω short circuit during restart, at $V_{in} = 48 \text{ V}$. Bottom trace (20 A/div., 100 ms/div.) is an expansion of the on-time portion of the top trace.



Comp. Des.	Description
C1, C2, C3,	2 x 1uF, 100V Ceramic Capacitor
C4, C5, C7, C8	4700pF Ceramic Capacitor
C6	100uF, 100V Electrolytic Capacitor
L1, L2	0.59mH, P0469NL Pulse Eng. Or, equiv

Fig. 36: Typical input EMI filter circuit to attenuate conducted emissions.

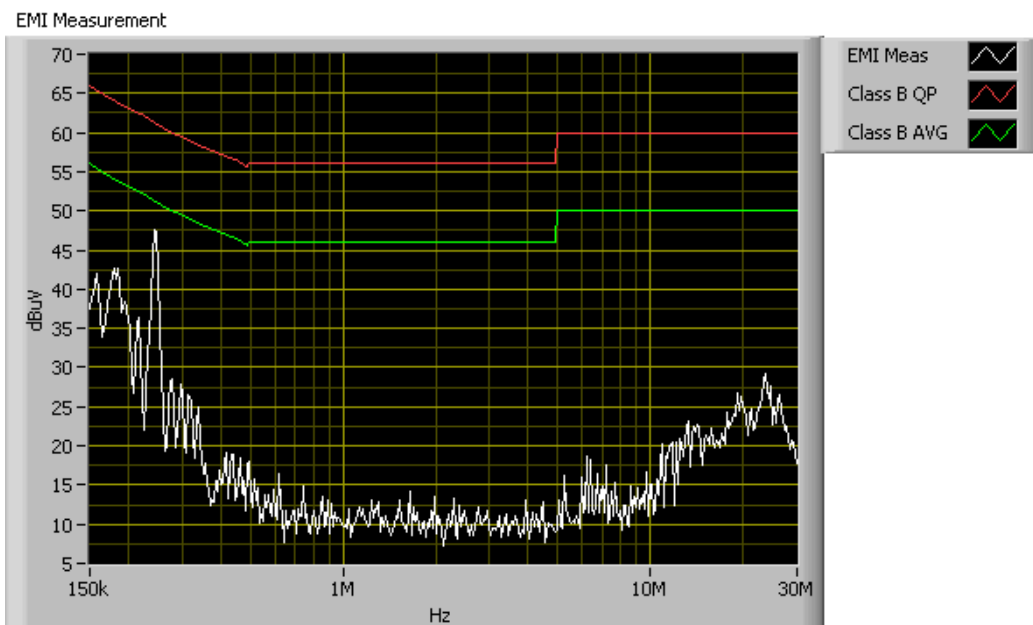


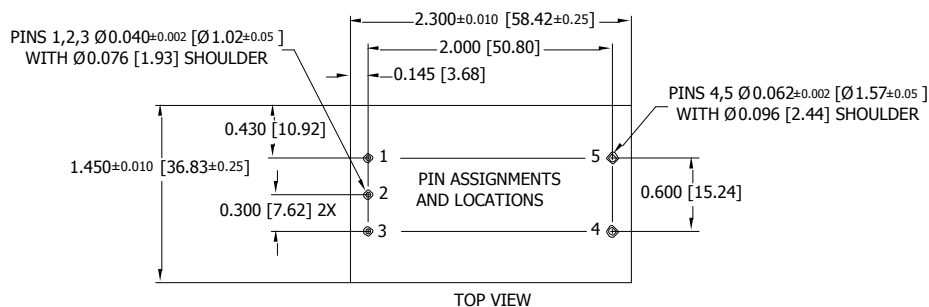
Fig. 37: Input conducted emissions measurement (Typ.) of QME48T35120 with input filter shown in Figure 36.
Conditions: $V_{IN}=48VDC$, $I_{OUT} = 35AMPS$



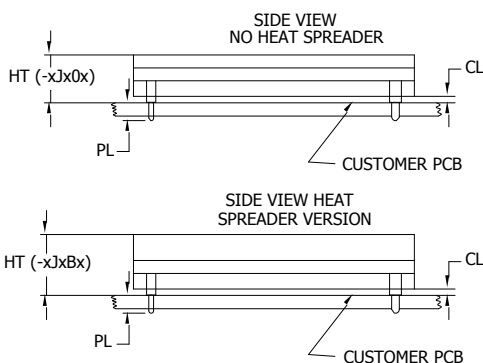
QME48T35120 DC-DC Converter 36-75 VDC Input; 12 VDC @ 35 A Output

Physical Information

QME48T35120 Pinout (Through-hole)



Pad/Pin Connections	
Pad/Pin #	Function
1	V _{IN} (+)
2	ON/OFF
3	V _{IN} (-)
4	V _{OUT} (-)
5	V _{OUT} (+)



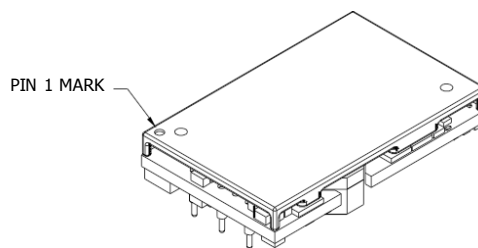
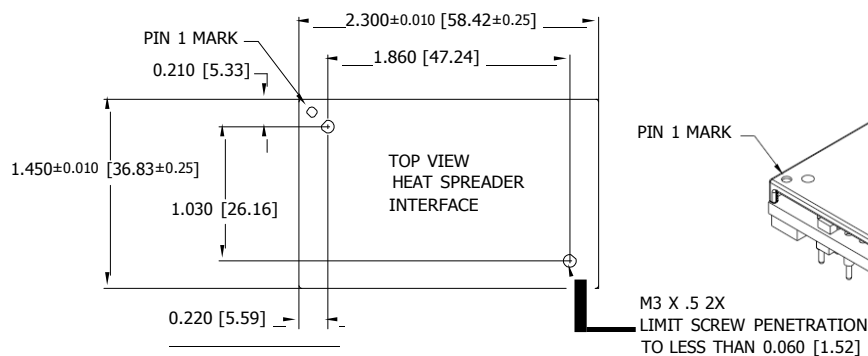
QME48T35120 Platform Notes

- All dimensions are in inches [mm]
- Pins 1-3 are Ø 0.040" [1.02] with Ø 0.076" [1.93] shoulder
- Pins 4 and 5 are Ø 0.062" [1.57] with are Ø 0.096" [2.44] shoulder
- Pin Material: Brass Alloy 360
- Pin Finish: Tin over Nickel
- Heatsink Mounting Screw: 3 in * lb maximum torque

	Height [HT]	Min Clearance [CL]	Special Features	Pin Option	Pin Length [PL]
					±0.005" [±0.13]
J	0.430" [10.4] Max	0.028" [0.71]	0	A	0.188" [4.78]
	0.500" +/-0.020 [12.70 +/-0.51]	0.028" [0.71]	B	B	0.145" [3.68]
				C	0.110" [2.79]

Baseplate (Heat Spreader) Interface

Information





QME48T35120 DC-DC Converter 36-75 VDC Input; 12 VDC @ 35 A Output

Converter Part Numbering Ordering Information

Product Series	Input Voltage	Mounting Scheme	Rated Load Current	Output Voltage		ON/OFF Logic	Maximum Height [HT]	Pin Length [PL]	Special Features	RoHS
QME	48	T	35	120	-	N	J	B	0	G
Quarter-Brick Format	36-75 V	T ⇒ Through-hole	35 A	120 ⇒ 12 V		N ⇒ Negative P ⇒ Positive	J ⇒ 0.430" for -xJx0x 0.520" for -xJxBx	Through hole A ⇒ 0.188" B ⇒ 0.145" C ⇒ 0.110"	0 ⇒ STD B ⇒ Baseplate option	No Suffix ⇒ RoHS lead-solder-exemption compliant G ⇒ RoHS compliant for all six substances

The example above describes P/N QME48T35120-NJB0G: 36-75 V input, through-hole mounting, 35 A @ 12 V output, negative ON/OFF logic, a maximum height of 0.430", 0.145" pin length, and standard (no baseplate). RoHS compliant for all 6 substances. Consult factory for availability of other options.

Notes:

1. NUCLEAR AND MEDICAL APPLICATIONS - Power-One products are not designed, intended for use in, or authorized for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems without the express written consent of the respective divisional president of Power-One, Inc.
2. TECHNICAL REVISIONS - The appearance of products, including safety agency certifications pictured on labels, may change depending on the date manufactured. Specifications are subject to change without notice.